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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	ARM® Cortex®-M0
Core Size	32-Bit Single-Core
Speed	50MHz
Connectivity	I ² C, IrDA, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, I ² S, LVD, POR, PS2, PWM, WDT
Number of I/O	49
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V
Data Converters	A/D 7x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/nuvoton-technology-corporation-america/nuc200sd2an

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- Compliant to ISO-7816-3 T=0, T=1
- Supports up to three ISO-7816-3 ports
- Separate receive / transmit 4 bytes entry FIFO for data payloads
- Programmable transmission clock frequency
- Programmable receiver buffer trigger level
- Programmable guard time selection (11 ETU ~ 266 ETU)
- One 24-bit and two 8-bit time-out counters for Answer to Request (ATR) and waiting times processing
- Supports auto inverse convention function
- Supports transmitter and receiver error retry and error limit function
- Supports hardware activation sequence process
- Supports hardware warm reset sequence process
- Supports hardware deactivation sequence process
- Supports hardware auto deactivation sequence when detecting the card removal
- 96-bit unique ID (UID)
- One built-in temperature sensor with 1°C resolution
- Brown-out Detector
 - With 4 levels: 4.4 V/3.7 V/2.7 V/2.2 V
 - Supports Brown-out Interrupt and Reset option
- Low Voltage Reset
 - Threshold voltage level: 2.0 V
- Operating Temperature: -40°C ~ 85°C
- Packages:
 - All Green package (RoHS)
 - LQFP 100-pin / 64-pin / 48-pin

- Supports Byte Suspend mode in 32-bit transmission
- Supports PDMA mode
- Supports three wire, no slave select signal, bi-direction interface
- I²C
 - Up to two sets of I²C device
 - Master/Slave mode
 - Bidirectional data transfer between masters and slaves
 - Multi-master bus (no central master)
 - Arbitration between simultaneously transmitting masters without corruption of serial data on the bus
 - Serial clock synchronization allowing devices with different bit rates to communicate via one serial bus
 - Serial clock synchronization used as a handshake mechanism to suspend and resume serial transfer
 - Programmable clocks allowing for versatile rate control
 - Supports multiple address recognition (four slave address with mask option)
 - Supports wake-up function
- I²S
 - Interface with external audio CODEC
 - Operate as either Master or Slave mode
 - Capable of handling 8-, 16-, 24- and 32-bit word sizes
 - Supports mono and stereo audio data
 - Supports I²S and MSB justified data format
 - Provides two 8 word FIFO data buffers, one for transmitting and the other for receiving
 - Generates interrupt requests when buffer levels cross a programmable boundary
 - Supports two DMA requests, one for transmitting and the other for receiving
- PS/2 Device
 - Host communication inhibit and request to send detection
 - Reception frame error detection
 - Programmable 1 to 16 bytes transmit buffer to reduce CPU intervention
 - Double buffer for data reception
 - Software override bus
- USB 2.0 Full-Speed Device
 - One set of USB 2.0 FS Device 12 Mbps
 - On-chip USB Transceiver
 - Provides 1 interrupt source with 4 interrupt events
 - Supports Control, Bulk In/Out, Interrupt and Isochronous transfers
 - Auto suspend function when no bus signaling for 3 ms
 - Provides 6 programmable endpoints
 - Includes 512 Bytes internal SRAM as USB buffer
 - Provides remote wake-up capability
- ADC
 - 12-bit SAR ADC with 760 kSPS
 - Up to 8-ch single-end input or 4-ch differential input
 - Single scan/single cycle scan/continuous scan
 - Each channel with individual result register
 - Scan on enabled channels
 - Threshold voltage detection
 - Conversion started by software programming or external input

- Supports PDMA mode
- Analog Comparator
 - Up to two analog comparators
 - External input or internal Band-gap voltage selectable at negative node
 - Interrupt when compare result change
 - Supports Power-down wake-up
- Smart Card Host (SC)
 - Compliant to ISO-7816-3 T=0, T=1
 - Supports up to three ISO-7816-3 ports
 - Separate receive / transmit 4 bytes entry FIFO for data payloads
 - Programmable transmission clock frequency
 - Programmable receiver buffer trigger level
 - Programmable guard time selection (11 ETU ~ 266 ETU)
 - One 24-bit and two 8-bit time-out counters for Answer to Request (ATR) and waiting times processing
 - Supports auto inverse convention function
 - Supports transmitter and receiver error retry and error limit function
 - Supports hardware activation sequence process
 - Supports hardware warm reset sequence process
 - Supports hardware deactivation sequence process
 - Supports hardware auto deactivation sequence when detecting the card removal
- 96-bit unique ID (UID)
- One built-in temperature sensor with 1°C resolution
- Brown-out Detector
 - With 4 levels: 4.4 V/3.7 V/2.7 V/2.2 V
 - Supports Brown-out Interrupt and Reset option
- Low Voltage Reset
 - Threshold voltage level: 2.0 V
- Operating Temperature: -40°C ~ 85°C
- Packages:
 - All Green package (RoHS)
 - LQFP 100-pin / 64-pin / 48-pin



3.2.1.2 NuMicro™ NUC200RxxAN LQFP 64-pin

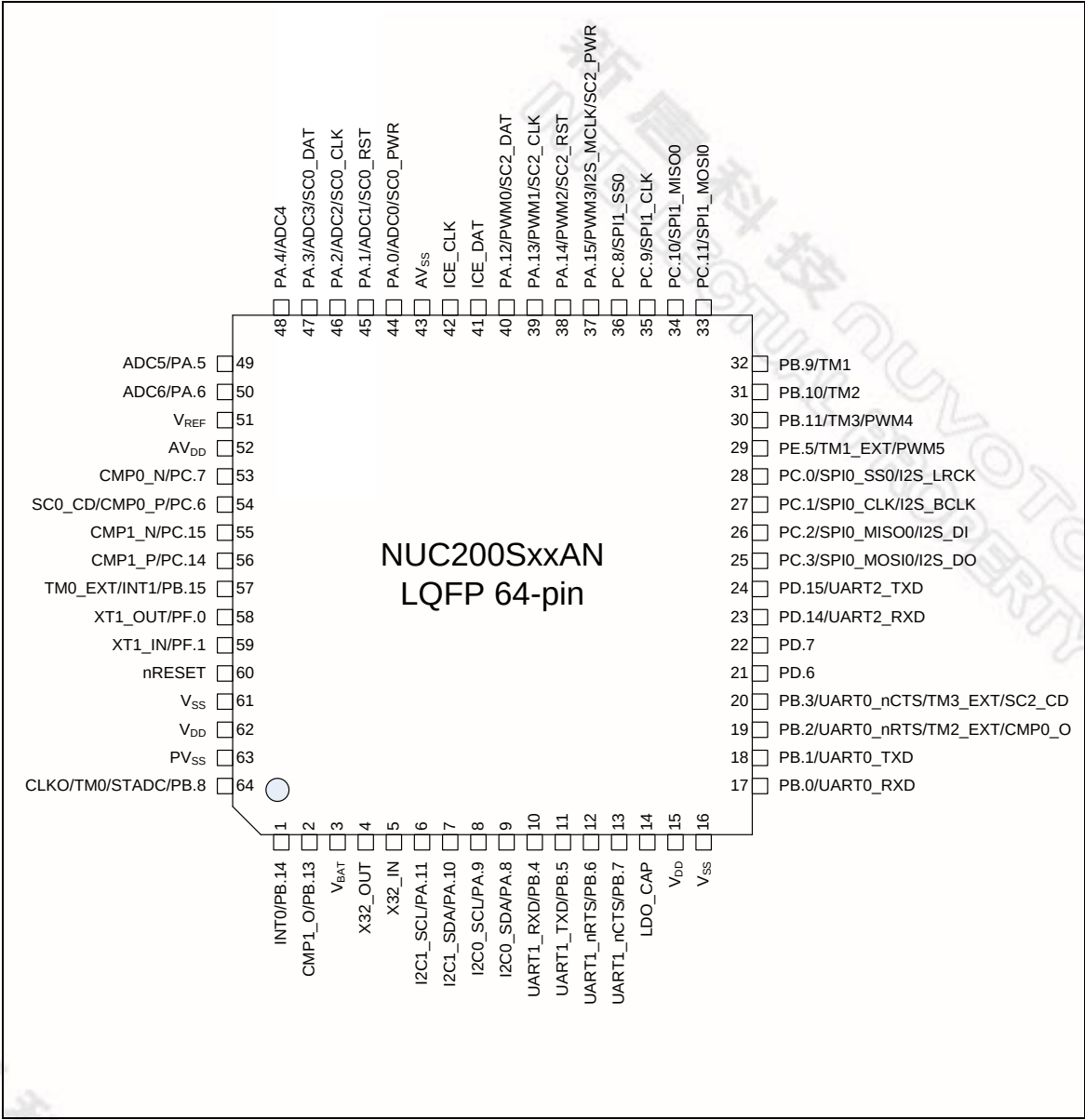


Figure 3-3 NuMicro™ NUC200SxxAN LQFP 64-pin Diagram



3.2.2.3 NuMicro™ NUC220LxxAN LQFP 48-pin

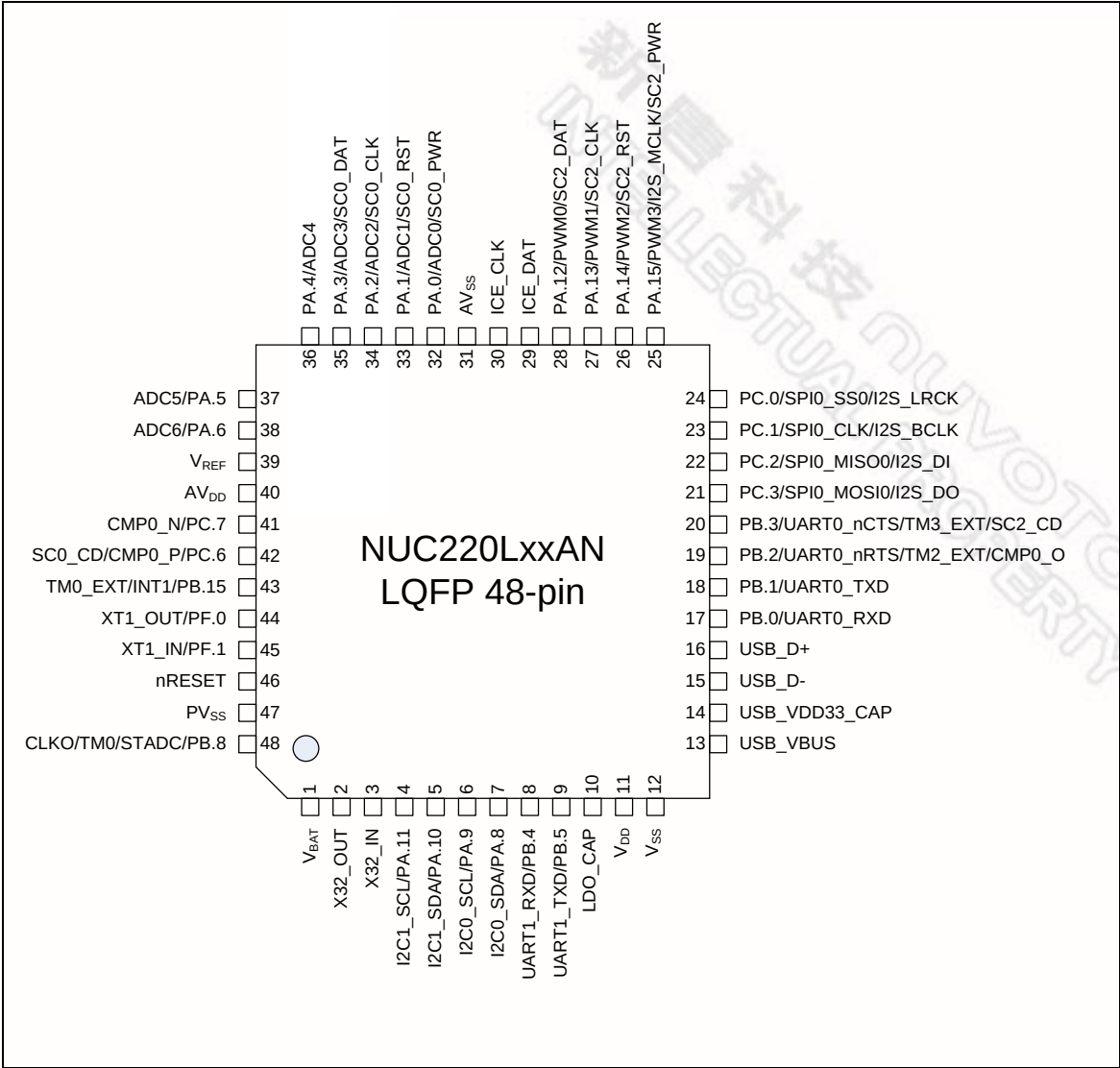


Figure 3-7 NuMicro™ NUC220LxxAN LQFP 48-pin Diagram



Pin No.			Pin Name	Pin Type	Description
LQFP 100-pin	LQFP 64-pin	LQFP 48-pin			
			SC1_PWR	O	SmartCard1 power pin.
76	49	37	PA.5	I/O	General purpose digital I/O pin.
			ADC5	AI	ADC5 analog input.
			SC1_RST	O	SmartCard1 reset pin.
77	50	38	PA.6	I/O	General purpose digital I/O pin.
			ADC6	AI	ADC6 analog input.
			SC1_CLK	I/O	SmartCard1 clock pin.
78			PA.7	I/O	General purpose digital I/O pin.
			ADC7	AI	ADC7 analog input.
			SC1_DAT	O	SmartCard1 data pin.
			SPI2_SS1	I/O	2 nd SPI2 slave select pin.
79	51	39	V _{REF}	AP	Voltage reference input for ADC.
80	52	40	AV _{DD}	AP	Power supply for internal analog circuit.
81			PD.0	I/O	General purpose digital I/O pin.
			SPI2_SS0	I/O	1 st SPI2 slave select pin.
82			PD.1	I/O	General purpose digital I/O pin.
			SPI2_CLK	I/O	SPI2 serial clock pin.
83			PD.2	I/O	General purpose digital I/O pin.
			SPI2_MISO0	I/O	1 st SPI2 MISO (Master In, Slave Out) pin.
84			PD.3	I/O	General purpose digital I/O pin.
			SPI2_MOSI0	I/O	1 st SPI2 MOSI (Master Out, Slave In) pin.
85			PD.4	I/O	General purpose digital I/O pin.
			SPI2_MISO1	I/O	2 nd SPI2 MISO (Master In, Slave Out) pin.
86			PD.5	I/O	General purpose digital I/O pin.
			SPI2_MOSI1	I/O	2 nd SPI2 MOSI (Master Out, Slave In) pin.
87	53	41	PC.7	I/O	General purpose digital I/O pin.
			CMP0_N	AI	Comparator0 negative input pin.
			SC1_CD	I	SmartCard1 card detect pin.
88	54	42	PC.6	I/O	General purpose digital I/O pin.
			CMP0_P	AI	Comparator0 positive input pin.

- NVIC:
 - ◆ 32 external interrupt inputs, each with four levels of priority
 - ◆ Dedicated Non-maskable Interrupt (NMI) input
 - ◆ Supports for both level-sensitive and pulse-sensitive interrupt lines
 - ◆ Supports Wake-up Interrupt Controller (WIC) and, providing Ultra-low Power Sleep mode
- Debug support:
 - ◆ Four hardware breakpoints
 - ◆ Two watchpoints
 - ◆ Program Counter Sampling Register (PCSR) for non-intrusive code profiling
 - ◆ Single step and vector catch capabilities
- Bus interfaces:
 - ◆ Single 32-bit AMBA-3 AHB-Lite system interface that provides simple integration to all system peripherals and memory
 - ◆ Single 32-bit slave port that supports the DAP (Debug Access Port).

5.2.4 System Memory Map

The NuMicro™ NUC200 Series provides 4G-byte addressing space. The memory locations assigned to each on-chip controllers are shown in the following table. The detailed register definition, memory space, and programming detailed will be described in the following sections for each on-chip peripheral. The NuMicro™ NUC200 Series only supports little-endian data format.

Address Space	Token	Controllers
Flash and SRAM Memory Space		
0x0000_0000 – 0x0001_FFFF	FLASH_BA	FLASH Memory Space (128 KB)
0x2000_0000 – 0x2000_3FFF	SRAM_BA	SRAM Memory Space (16 KB)
AHB Controllers Space (0x5000_0000 – 0x501F_FFFF)		
0x5000_0000 – 0x5000_01FF	GCR_BA	System Global Control Registers
0x5000_0200 – 0x5000_02FF	CLK_BA	Clock Control Registers
0x5000_0300 – 0x5000_03FF	INT_BA	Interrupt Multiplexer Control Registers
0x5000_4000 – 0x5000_7FFF	GPIO_BA	GPIO Control Registers
0x5000_8000 – 0x5000_BFFF	PDMA_BA	Peripheral DMA Control Registers
0x5000_C000 – 0x5000_FFFF	FMC_BA	Flash Memory Control Registers
APB1 Controllers Space (0x4000_0000 ~ 0x400F_FFFF)		
0x4000_4000 – 0x4000_7FFF	WDT_BA	Watchdog Timer Control Registers
0x4000_8000 – 0x4000_BFFF	RTC_BA	Real Time Clock (RTC) Control Register
0x4001_0000 – 0x4001_3FFF	TMR01_BA	Timer0/Timer1 Control Registers
0x4002_0000 – 0x4002_3FFF	I2C0_BA	I ² C0 Interface Control Registers
0x4003_0000 – 0x4003_3FFF	SPI0_BA	SPI0 with master/slave function Control Registers
0x4003_4000 – 0x4003_7FFF	SPI1_BA	SPI1 with master/slave function Control Registers
0x4004_0000 – 0x4004_3FFF	PWMA_BA	PWM0/1/2/3 Control Registers
0x4005_0000 – 0x4005_3FFF	UART0_BA	UART0 Control Registers
0x4006_0000 – 0x4006_3FFF	USBD_BA	USB 2.0 FS device Controller Registers
0x400D_0000 – 0x400D_3FFF	ACMP_BA	Analog Comparator Control Registers
0x400E_0000 – 0x400E_FFFF	ADC_BA	Analog-Digital-Converter (ADC) Control Registers
APB2 Controllers Space (0x4010_0000 ~ 0x401F_FFFF)		

IRQ23_SRC	INT_BA+0x5C	R	IRQ23 (USB) interrupt source identity	0XXXXX_XXXX
IRQ24_SRC	INT_BA+0x60	R	IRQ24 (PS/2) interrupt source identity	0XXXXX_XXXX
IRQ25_SRC	INT_BA+0x64	R	IRQ25 (ACMP) interrupt source identity	0XXXXX_XXXX
IRQ26_SRC	INT_BA+0x68	R	IRQ26 (PDMA) interrupt source identity	0XXXXX_XXXX
IRQ27_SRC	INT_BA+0x6C	R	IRQ27 (I ² S) interrupt source identity	0XXXXX_XXXX
IRQ28_SRC	INT_BA+0x70	R	IRQ28 (PWRWU) interrupt source identity	0XXXXX_XXXX
IRQ29_SRC	INT_BA+0x74	R	IRQ29 (ADC) interrupt source identity	0XXXXX_XXXX
IRQ30_SRC	INT_BA+0x78	R	IRQ30 (IRCT) interrupt source identity	0XXXXX_XXXX
IRQ31_SRC	INT_BA+0x7C	R	IRQ31 (RTC) interrupt source identity	0XXXXX_XXXX
NMI_SEL	INT_BA+0x80	R/W	NMI source interrupt select control register	0x0000_0000
MCU_IRQ	INT_BA+0x84	R/W	MCU interrupt request source register	0x0000_0000

5.3.2 Clock Generator

The clock generator consists of 5 clock sources as listed below:

- One external 32.768 kHz low speed crystal
- One external 4~24 MHz high speed crystal
- One programmable PLL FOUT (PLL source consists of external 4~24 MHz high speed crystal and internal 22.1184 MHz high speed oscillator)
- One internal 22.1184 MHz high speed oscillator
- One internal 10 kHz low speed oscillator

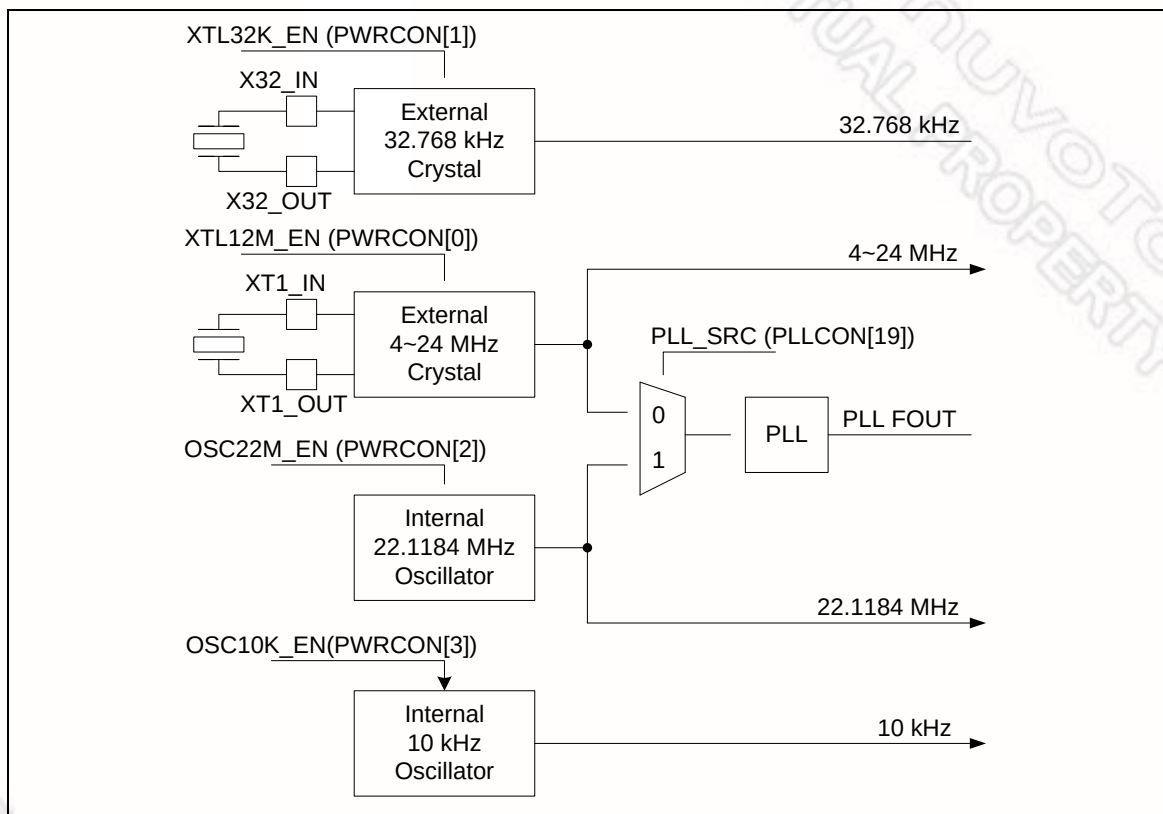


Figure 5-5 Clock Generator Block Diagram

5.7 PWM Generator and Capture Timer (PWM)

5.7.1 Overview

The NuMicro™ NUC200 series has 2 sets of PWM group supporting a total of 4 sets of PWM generators that can be configured as 8 independent PWM outputs, PWM0~PWM7, or as 4 complementary PWM pairs, (PWM0, PWM1), (PWM2, PWM3), (PWM4, PWM5) and (PWM6, PWM7) with 4 programmable Dead-zone generators.

Each PWM generator has one 8-bit prescaler, one clock divider with 5 divided frequencies (1, 1/2, 1/4, 1/8, 1/16), two PWM Timers including two clock selectors, two 16-bit PWM counters for PWM period control, two 16-bit comparators for PWM duty control and one Dead-zone generator. The 4 sets of PWM generators provide eight independent PWM interrupt flags set by hardware when the corresponding PWM period down counter reaches 0. Each PWM interrupt source with its corresponding enable bit can cause CPU to request PWM interrupt. The PWM generators can be configured as one-shot mode to produce only one PWM cycle signal or auto-reload mode to output PWM waveform continuously.

When PCR.DZEN01 is set, PWM0 and PWM1 perform complementary PWM paired function; the paired PWM period, duty and Dead-time are determined by PWM0 timer and Dead-zone generator 0. Similarly, the complementary PWM pairs of (PWM2, PWM3), (PWM4, PWM5) and (PWM6, PWM7) are controlled by PWM2, PWM4 and PWM6 timers and Dead-zone generator 2, 4 and 6, respectively. Refer to 錯誤! 找不到參照來源。 and 錯誤! 找不到參照來源。 for the architecture of PWM Timers.

To prevent PWM driving output pin with unsteady waveform, the 16-bit period down counter and 16-bit comparator are implemented with double buffer. When user writes data to counter/comparator buffer registers the updated value will be load into the 16-bit down counter/comparator at the time down counter reaching 0. The double buffering feature avoids glitch at PWM outputs.

When the 16-bit period down counter reaches 0, the interrupt request is generated. If PWM-timer is set as auto-reload mode, when the down counter reaches 0, it is reloaded with PWM Counter Register (CNRx) automatically then start decreasing, repeatedly. If the PWM-timer is set as one-shot mode, the down counter will stop and generate one interrupt request when it reaches 0.

The value of PWM counter comparator is used for pulse high width modulation. The counter control logic changes the output to high level when down-counter value matches the value of compare register.

The alternate feature of the PWM-timer is digital input Capture function. If Capture function is enabled the PWM output pin is switched as capture input mode. The Capture0 and PWM0 share one timer which is included in PWM0 and the Capture1 and PWM1 share PWM1 timer, and etc. Therefore user must setup the PWM-timer before enable Capture feature. After capture feature is enabled, the capture always latched PWM-counter to Capture Rising Latch Register (CRLR) when input channel has a rising transition and latched PWM-counter to Capture Falling Latch Register (CFLR) when input channel has a falling transition. Capture channel 0 interrupt is programmable by setting CCR0.CRL_IE0[1] (Rising latch Interrupt enable) and CCR0.CFL_IE0[2] (Falling latch Interrupt enable) to decide the condition of interrupt occur. Capture channel 1 has the same feature by setting CCR0.CRL_IE1[17] and CCR0.CFL_IE1[18]. And capture channel 2 to channel 3 on each group have the same feature by setting the corresponding control bits in CCR2. For each group, whenever Capture issues Interrupt 0/1/2/3, the PWM counter 0/1/2/3 will be reload at this moment.

The maximum captured frequency that PWM can capture is confined by the capture interrupt latency. When capture interrupt occurred, software will do at least three steps, including: Read PIIR to get interrupt source and Read CRLRx/CFLRx(x=0~3) to get capture value and finally write 1 to clear PIIR to 0. If interrupt latency will take time T0 to finish, the capture signal mustn't transition during this interval (T0). In this case, the maximum capture frequency will be 1/T0. For

	Parameter	Register	Parameter	Register	Parameter	Register
921600	x	x	A=0,B=11	0x2B00_0000	A=22	0x3000_0016
460800	A=1	0x0000_0001	A=1,B=15 A=2,B=11	0x2F00_0001 0x2B00_0002	A=46	0x3000_002E
230400	A=4	0x0000_0004	A=4,B=15 A=6,B=11	0x2F00_0004 0x2B00_0006	A=94	0x3000_005E
115200	A=10	0x0000_000A	A=10,B=15 A=14,B=11	0x2F00_000A 0x2B00_000E	A=190	0x3000_00BE
57600	A=22	0x0000_0016	A=22,B=15 A=30,B=11	0x2F00_0016 0x2B00_001E	A=382	0x3000_017E
38400	A=34	0x0000_0022	A=62,B=8 A=46,B=11 A=34,B=15	0x2800_003E 0x2B00_002E 0x2F00_0022	A=574	0x3000_023E
19200	A=70	0x0000_0046	A=126,B=8 A=94,B=11 A=70,B=15	0x2800_007E 0x2B00_005E 0x2F00_0046	A=1150	0x3000_047E
9600	A=142	0x0000_008E	A=254,B=8 A=190,B=11 A=142,B=15	0x2800_00FE 0x2B00_00BE 0x2F00_008E	A=2302	0x3000_08FE
4800	A=286	0x0000_011E	A=510,B=8 A=382,B=11 A=286,B=15	0x2800_01FE 0x2B00_017E 0x2F00_011E	A=4606	0x3000_11FE

Table 5-6 UART Baud Rate Setting Table

The UART0 and UART1 controllers support the auto-flow control function that uses two low-level signals, nCTS (clear-to-send) and nRTS (request-to-send), to control the flow of data transfer between the chip and external devices (e.g. Modem). When auto-flow is enabled, the UART is not allowed to receive data until the UART asserts nRTS to external device. When the number of bytes in the RX FIFO equals the value of RTS_TRI_LEV (UA_FCR [19:16]), the nRTS is de-asserted. The UART sends data out when UART controller detects nCTS is asserted from external device. If a valid asserted nCTS is not detected the UART controller will not send data out.

The UART controllers also provides Serial IrDA (SIR, Serial Infrared) function (User must set IrDA_EN (UA_FUN_SEL [1]) to enable IrDA function). The SIR specification defines a short-range infrared asynchronous serial transmission mode with 1 start bit, 8 data bits, and 1 stop bit. The maximum data rate supports up to 115.2 Kbps (half duplex). The IrDA SIR block contains an IrDA SIR Protocol encoder/decoder. The IrDA SIR Protocol encoder/decoder is half-duplex only. So it cannot transmit and receive data at the same time. The IrDA SIR physical layer specifies a minimum 10ms transfer delay between transmission and reception, and this delay feature must be implemented by software.

The alternate function of UART controllers is LIN (Local Interconnect Network) function. The LIN mode is selected by setting the UA_FUN_SEL[1:0] to '01'. In LIN mode, 1 start bit and 8 data bits format with 1 stop bit are required in accordance with the LIN standard.

For NuMicro™ NUC200 Series, another alternate function of UART controllers is RS-485 9-bit mode, and direction control provided by nRTS pin or can program GPIO (PB.2 for UART0_nRTS and PB.6 for UART1_nRTS) to implement the function by software. The RS-485 mode is selected

5.20 FLASH MEMORY CONTROLLER (FMC)

5.20.1 Overview

The NuMicro™ NUC200 Series has 128/64/32K bytes on-chip embedded Flash for application program memory (APROM) that can be updated through ISP procedure. The In-System-Programming (ISP) function enables user to update program memory when chip is soldered on PCB. After chip is powered on, Cortex™-M0 CPU fetches code from APROM or LDROM decided by boot select (CBS) in Config0. By the way, the NuMicro™ NUC200 Series also provides additional DATA Flash for user to store some application dependent data. For 128K bytes APROM device, the data flash is shared with original 128K program memory and its start address is configurable in Config1. For 64K/32K bytes APROM device, the data flash is fixed at 4K.

5.20.2 Features

- Runs up to 50 MHz with zero wait state for continuous address read access
- All embedded flash memory supports 512 bytes page erase
- 128/64/32 KB application program memory (APROM)
- 4 KB In-System-Programming (ISP) loader program memory (LDROM)
- 4KB data flash for 64/32 KB APROM device
- Configurable data flash size for 128KB APROM device
- Configurable or fixed 4 KB data flash with 512 bytes page erase unit
- Supports In-Application-Programming (IAP) to switch code between APROM and LDROM without reset
- In-System-Programming (ISP) to update on-chip Flash

6.2 DC Electrical Characteristics

($V_{DD}-V_{SS}=5.5\text{ V}$, $T_A = 25^\circ\text{C}$, $F_{OSC} = 50\text{ MHz}$ unless otherwise specified.)

PARAMETER	SYM.	SPECIFICATION				TEST CONDITIONS
		MIN.	TYP.	MAX.	UNIT	
Operation Voltage	V_{DD}	2.5		5.5	V	$V_{DD} = 2.5\text{V} \sim 5.5\text{V}$ up to 50 MHz
Power Ground	V_{SS} AV_{SS}	-0.3			V	
LDO Output Voltage	V_{LDO}	1.62	1.8	1.98	V	$V_{DD} > 2.5\text{V}$
Analog Operating Voltage	AV_{DD}		V_{DD}		V	When system used analog function, please refer to chapter 6.4 for corresponding analog operating voltage
Operating Current Normal Run Mode at 50 MHz	I_{DD1}		34		mA	$V_{DD} = 5.5\text{V}$, All IP and PLL enabled, XTAL = 12 MHz
	I_{DD2}		15		mA	$V_{DD} = 5.5\text{V}$, All IP disabled and PLL enabled, XTAL = 12 MHz
	I_{DD3}		32		mA	$V_{DD} = 3.3\text{V}$, All IP and PLL enabled, XTAL = 12 MHz
	I_{DD4}		14		mA	$V_{DD} = 3.3\text{V}$, All IP disabled and PLL enabled, XTAL = 12 MHz
Operating Current Normal Run Mode at 12 MHz	I_{DD5}		8.5		mA	$V_{DD} = 5.5\text{V}$, All IP enabled and PLL disabled, XTAL = 12 MHz
	I_{DD6}		3.6		mA	$V_{DD} = 5.5\text{V}$, All IP and PLL disabled, XTAL = 12 MHz
	I_{DD7}		7.5		mA	$V_{DD} = 3.3\text{V}$, All IP enabled and PLL disabled, XTAL = 12 MHz

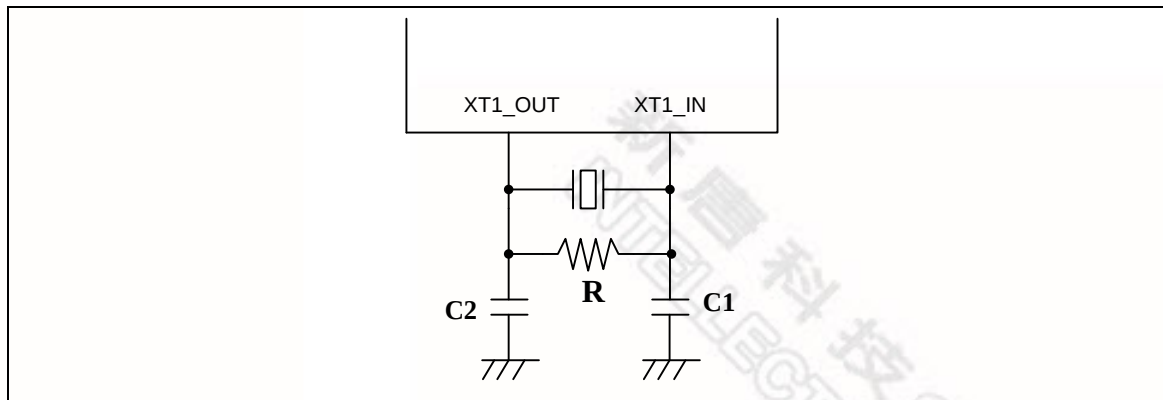


Figure 6-1 Typical Crystal Application Circuit

6.3.3 External 32.768 kHz Low Speed Crystal Oscillator

PARAMETER	CONDITION	MIN.	TYP.	MAX.	UNIT
Operation Voltage V_{DD}	-	2.5	-	5.5	V
Operation Temperature	-	-40	-	85	°C
Operation Current	32.768KHz at $V_{DD}=5V$		1.5		μA
Clock Frequency	External crystal	-	32.768	-	kHz

6.3.4 Internal 22.1184 MHz High Speed Oscillator

PARAMETER	CONDITION	MIN.	TYP.	MAX.	UNIT
Operation Voltage V_{DD}	-	2.5	-	5.5	V
Center Frequency	-	-	22.1184	-	MHz
Calibrated Internal Oscillator Frequency	+25°C; $V_{DD} = 5V$	-1	-	+1	%
	-40°C ~ +85°C; $V_{DD} = 2.5V \sim 5.5V$	-3	-	+3	%
Operation Current	$V_{DD} = 5V$	-	500	-	uA

6.3.5 Internal 10 kHz Low Speed Oscillator

PARAMETER	CONDITION	MIN.	TYP.	MAX.	UNIT
Operation Voltage V_{DD}	-	2.5	-	5.5	V
Center Frequency	-	-	10	-	kHz
Calibrated Internal Oscillator Frequency	+25°C; $V_{DD} = 5V$	-30	-	+30	%

6.4.8 USB PHY Specification

6.4.8.1 USB DC Electrical Characteristics

SYMBOL	PARAMETER	CONDITION	MIN.	TYP.	MAX.	UNIT
V _{IH}	Input High (driven)		2.0			V
V _{IL}	Input Low				0.8	V
V _{DI}	Differential Input Sensitivity	PADP-PADM	0.2			V
V _{CM}	Differential Common-mode Range	Includes V _{DI} range	0.8		2.5	V
V _{SE}	Single-ended Receiver Threshold		0.8		2.0	V
	Receiver Hysteresis			200		mV
V _{OL}	Output Low (driven)		0		0.3	V
V _{OH}	Output High (driven)		2.8		3.6	V
V _{CRS}	Output Signal Cross Voltage		1.3		2.0	V
R _{PU}	Pull-up Resistor		1.425		1.575	kΩ
V _{TRM}	Termination Voltage for Upstream Port Pull-up (RPU)		3.0		3.6	V
Z _{DRV}	Driver Output Resistance	Steady state drive*		10		Ω
C _{IN}	Transceiver Capacitance	Pin to GND			20	pF

*Driver output resistance doesn't include series resistor resistance.

6.4.8.2 USB Full-Speed Driver Electrical Characteristics

SYMBOL	PARAMETER	CONDITION	MIN.	TYP.	MAX.	UNIT
T _{FR}	Rise Time	C _L =50p	4		20	ns
T _{FF}	Fall Time	C _L =50p	4		20	ns
T _{FRFF}	Rise and Fall Time Matching	T _{FRFF} =T _{FR} /T _{FF}	90		111.11	%

6.4.8.3 USB Power Dissipation

SYMBOL	PARAMETER	CONDITION	MIN.	TYP.	MAX.	UNIT
I _{VBUS}	USB_VBUS Current (Steady State)	Standby		50		μA

8 REVISION HISTORY

Revision	Date	Description
V1.00	June 07, 2012	Initial release

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